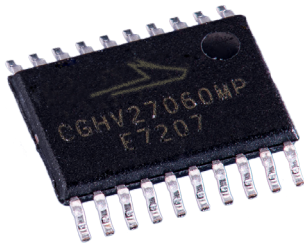
CGHV27060MP

60 W, DC - 2.7 GHz, 50 V, GaN HEMT for Communication Amplifiers and Pulse Radar Applications



PN: CGHV27060MP

Description

Wolfspeed's CGHV27060MP is a 60 W gallium nitride (GaN) high electron mobility transistor (HEMT) housed in a small plastic SMT package 4.4 mm x 6.5 mm. The transistor is a broadband device with no internal input or output match which allows for the agility to apply to a wide range of frequencies from UHF thru 2.7GHz. The CGHV27060MP makes for an excellent transistor for pulsed applications at UHF, L-Band, or low S-Band (<2.7GHz). Additionally, the transistor is well suited for communication amplifiers in the power class of 10 to 15 W average power in high efficiency topologies such as Class A/B, F, or Doherty amplifiers.

Typical Performance Over 2.5 - 2.7 GHz (T_C = 25°C) of Demonstration Amplifier

Parameter	2.5 GHz	2.6 GHz	2.7 GHz	Units
Gain	16.7	16.4	16.2	dB
Output Power	94	87	83	W
Drain Efficiency	69	69	64	%

Note: Measured in the CGHV27060MP-AMP1 amplifier circuit, under pulse width 100µs, 10% duty cycle, P_{IN} = 33 dBm.

Typical Performance Over 2.5 - 2.7 GHz (T_C = 25°C) of Demonstration Amplifier

Parameter	2.5 GHz	2.6 GHz	2.7 GHz	Units
Gain	18.4	18.2	17.6	dB
ACLR	-33.2	-34.5	-35.8	dBc
Drain Efficiency	33	33	32	%

Note: Measured in the CGHV27060MP-AMP1 amplifier circuit, under WCDMA 3GPP test model 1, 64 DPCH, 45% clipping, PAR = 7.5 dB @ 0.01% probability on CCDF, V_{DD} = 50 V, I_{DS} = 125 mA, P_{AVE} = 41.5 dBm

Features - Pulsed

- 16.5 dB Gain at Pulsed P_{SAT}
- 70% Efficiency at Pulsed P_{SAT}
- 85 W at Pulsed P_{SAT}

Features - Linear

- 18 dB Gain at P_{AVE} = 14 W
- -35 dBc ACLR at P_{AVE} = 14 W
- 33% Efficiency at P_{AVE} = 14 W
- High Degree of DPD Correction Can be Applied

Listing of Available Hardware Application Circuits / Demonstration Circuits

Application Circuit	Operating Frequency	Amplifier Class	Operating Voltage
CGHV27060MP-AMP1	2.5 - 2.7 GHz	Class A/B	50 V
CGHV27060MP-AMP3	0.8 - 2.7 GHz	Class A/B	50 V
CGHV27060MP-AMP4	0.1 - 1.0 GHz	Class A/B	45 V

Large Signal Models Available for ADS and MWO

RoHS compliant

4600 Silicon Drive | Durham, NC 27703 | Tel: +1.919.313.5300

Absolute Maximum Ratings (not simultaneous) at 25°C Case Temperature

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V_{DSS}	150	V	25˚C
Gate-to-Source Voltage	V_{GS}	-10, +2		
Storage Temperature	T_{STG}	-65, +150	°C	
Operating Junction Temperature	T_J	225		
Maximum Forward Gate Current	I_{GMAX}	10.4	mA	25°C
Maximum Drain Current[1]	I_{DMAX}	6.3	A	
Soldering Temperature[2]	T_S	245	°C	
Thermal Resistance, Junction to Case[3]	$R_{\theta JC}$	2.6	°C/W	85°C, P_{DISS} = 52 W (CW)
Thermal Resistance Pulsed 10%, 100µs, Junction to Case		1.95		85°C, P_{DISS} = 62W, 100µs/10%
Case Operating Temperature[4]	T_C	-40, +150	°C	

Notes:
[1] Current limit for long term, reliable operation
[2] Refer to the Application Note on soldering at wolfspeed.com/rf/document-library
[3] Measured for the CGHV27060MP
[4] See also, the Power Dissipation De-rating Curve on Page 12

Electrical Characteristics (T_C = 25°C)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics[1]						
Gate Threshold Voltage	$V_{GS(th)}$	-3.8	-3.0	-2.3	V_{DC}	V_{DS} = 10 V, I_D = 10.4 mA
Gate Quiescent Voltage	$V_{GS(Q)}$	–	-2.7	–		V_{DS} = 50 V, I_D = 125 mA
Saturated Drain Current[2]	I_{DS}	6.8	9.7	–	A	V_{DS} = 6.0 V, V_{GS} = 2.0 V
Drain-Source Breakdown Voltage	V_{BR}	125	–	–	V_{DC}	V_{GS} = -8 V, I_D = 10.4 mA
RF Characteristics[4] (T_C = 25°C, F_0 = 2.5 GHz unless otherwise noted)						
Output Power[3]	P_{OUT}	–	95	–	W	V_{DD} = 50 V, I_{DQ} = 125 mA, P_{IN} = 35 dBm
Pulsed Drain Efficiency[3]	η	–	64	–	%	
Gain[3]	G	–	18.3	–	dB	V_{DD} = 50 V, I_{DQ} = 125 mA, P_{IN} = 10 dBm
Output Mismatch Stress[3]	VSWR	–	–	10:1	Ψ	No damage at all phase angles, V_{DD} = 50 V, I_{DQ} = 125 mA, P_{OUT} = 60 W Pulsed
Dynamic Characteristics						
Input Capacitance[5]	C_{GS}	–	15.3	–	pF	V_{DS} = 50 V, V_{GS} = -8 V, f = 1 MHz
Output Capacitance[5]	C_{DS}	–	4.7	–		
Feedback Capacitance	C_{GD}	–	0.5	–		

Notes:
[1] Measured on wafer prior to packaging
[2] Scaled from PCM data
[3] Pulse Width = 100µs, Duty Cycle = 10%
[4] Measured in CGHV27060MP-TB high volume test fixture
[5] Includes package

Electrical Characteristics When Tested in CGHV27060MP-AMP1 Under WCDMA Modulation

Characteristics	Symbol	Typ.	Units	Conditions
DC Characteristics[1]				
Small Signal Gain at 2.6 GHz[2]	G_{SS}	19.2	dB	V_{DD} = 50 V, I_{DQ} = 125 mA, P_{IN} = 10 dBm
Gain at 2.5 GHz[2]	G	18.4		V_{DD} = 50 V, I_{DQ} = 125 mA, P_{IN} = 41.5 dBm
Gain at 2.6 GHz[2]		18.6		
Gain at 2.7 GHz[2]		18.1		
ACLR at 2.5 GHz[2]	ACLR	-35	dBc	
ACLR at 2.6 GHz[2]				
ACLR at 2.7 GHz[2]				
Drain Efficiency at 2.5 GHz[2,3]	η	32	%	
Drain Efficiency at 2.6 GHz[2,3]		33		
Drain Efficiency at 2.7 GHz[2,3]		31		

Notes:
[1] Measured in CGHV27060MP-AMP1 Application Circuit
[2] Single Carrier WCDMA, 3GPP Test Model 1, 64 DPCH, 45% Clipping, PAR = 7.5 dB @ 0.01% Probability on CCDF
[3] Drain Efficiency = P_{OUT} / P_{DC}

Typical Performance in Application Circuit CGHV27060MP-AMP1

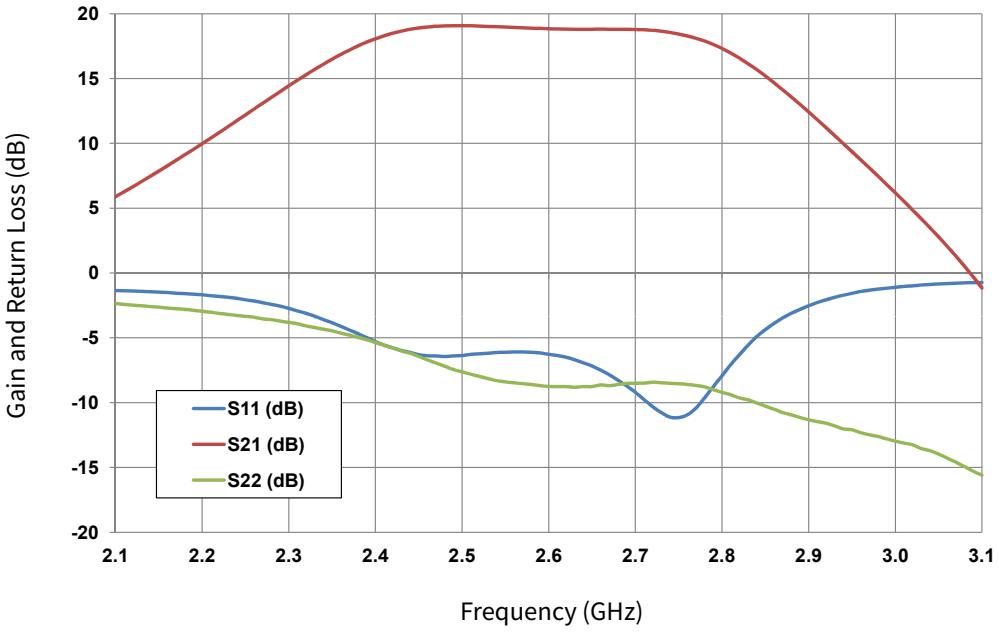


Figure 1. Small Signal Gain and Return Losses of the CGHV27060MP Measured in Demonstration Amplifier Circuit CGHV27060MP-AMP1

Typical Performance in Application Circuit CGHV27060MP-AMP1

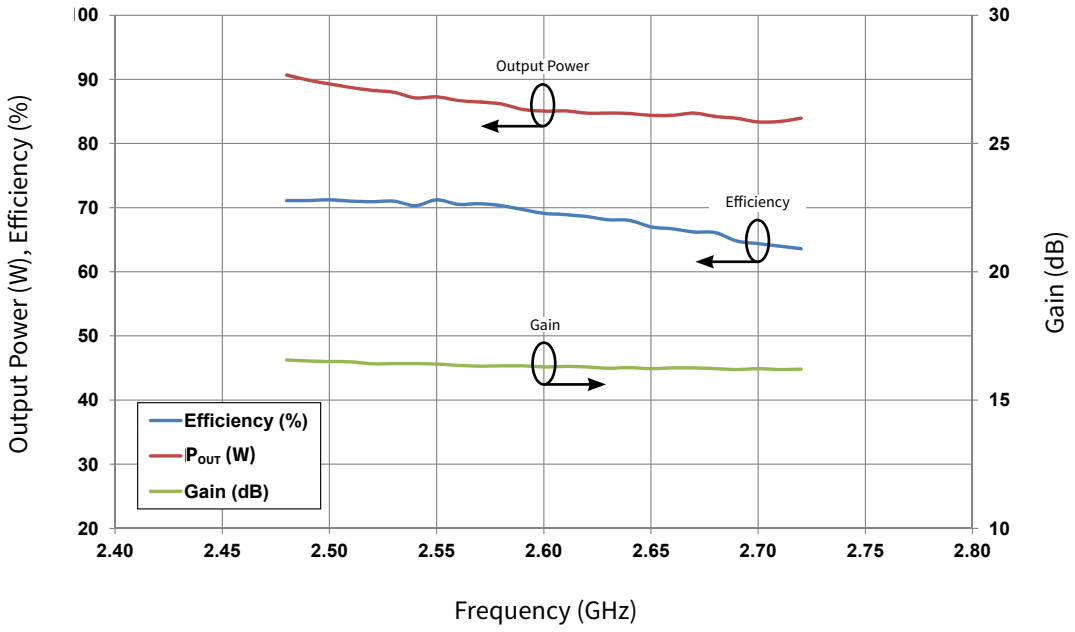


Figure 2. Gain, Output Power, and Drain Efficiency under 100µs Pulse Width, 10% Duty Cycle for the CGHV27060MP Measured in Demonstration Amplifier Circuit CGHV27060MP-AMP1

Electrical Characteristics When Tested in CGHV27060MP-AMP3, MILCOM

Characteristics	Symbol	Typ.	Max.	Units	Conditions
RF Characteristics[1] (T_C = 25°C, F_0 = 0.8 - 2.7 GHz unless otherwise noted)					
Gain	G	16.5	–	dB	V_{DD} = 50 V, I_{DQ} = 120 mA, P_{IN} = 0 dBm
Output Power	P_{OUT}	48.5	–	dBm	V_{DD} = 50 V, I_{DQ} = 120 mA, P_{IN} = 37 dBm
Drain Efficiency	η	60	–	%	
Output Mismatch Stress	VSWR	–	3:1	Ψ	No damage at all phase angles, V_{DD} = 50 V, I_{DQ} = 120 mA, P_{IN} = 37 dBm

Note:
[1] Measured in CGHV27060MP-AMP3 Application Circuit

Typical Performance in Application Circuit CGHV27060MP-AMP3, MILCOM

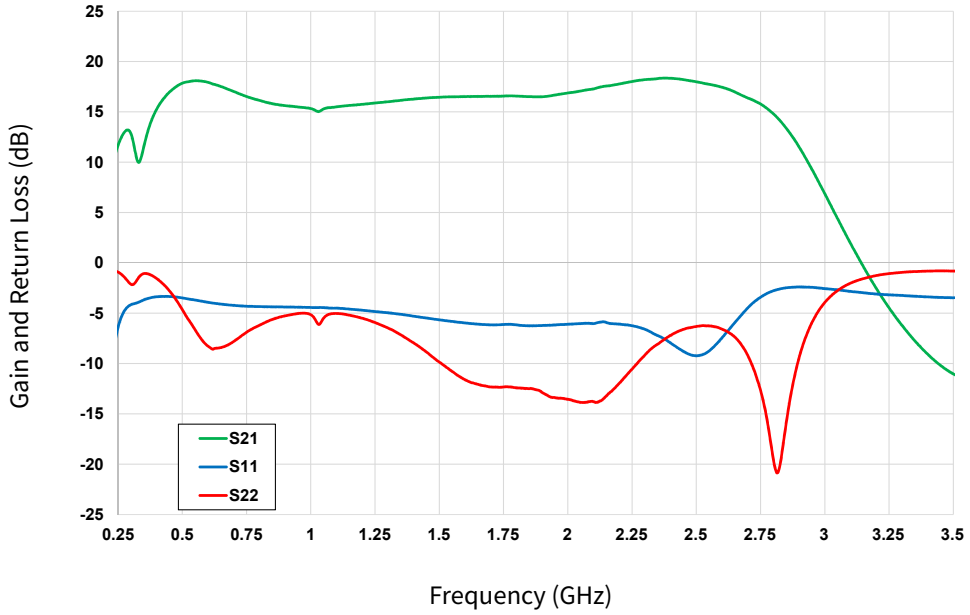


Figure 3. Small Signal Gain and Return Losses Measured of the CGHV27060MP Measured in Demonstration Amplifier Circuit CGHV27060MP-AMP3
V_{DD} = 50 V, I_{DQ} = 120 mA

Typical Performance in Application Circuit CGHV27060MP-AMP3

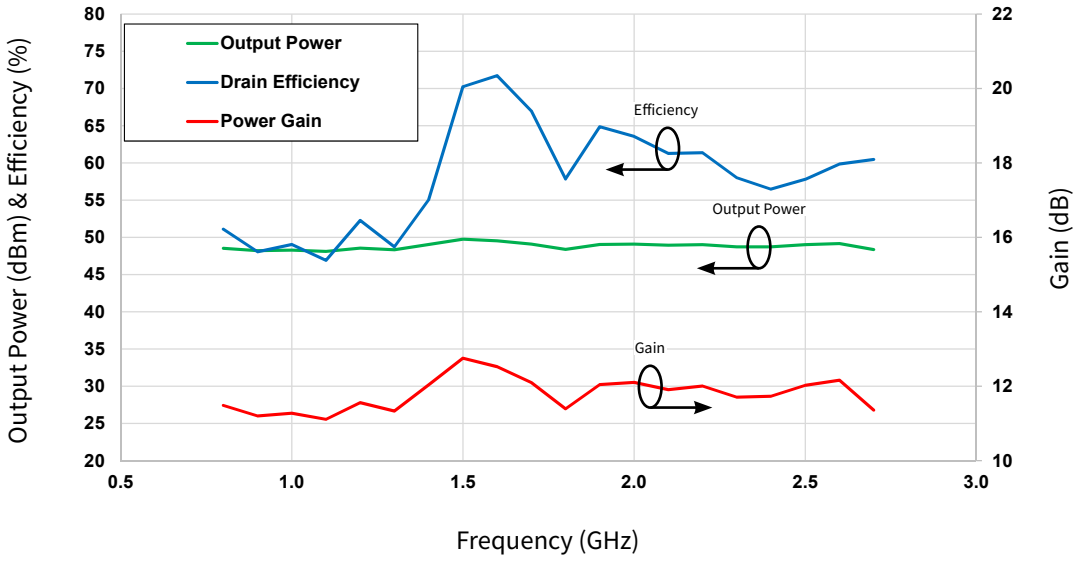
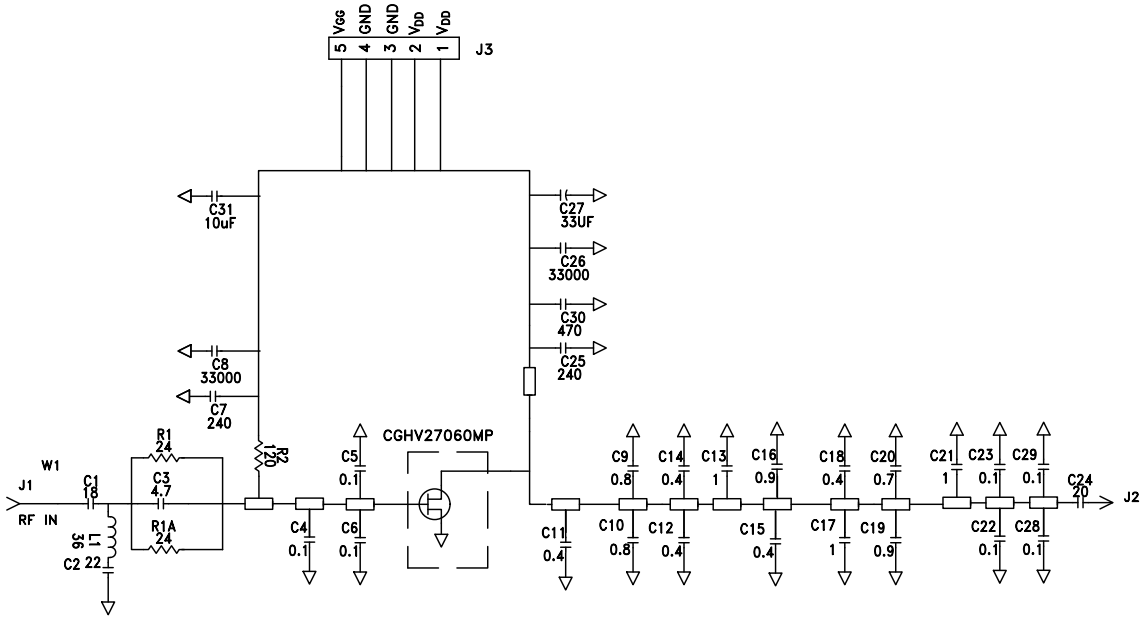
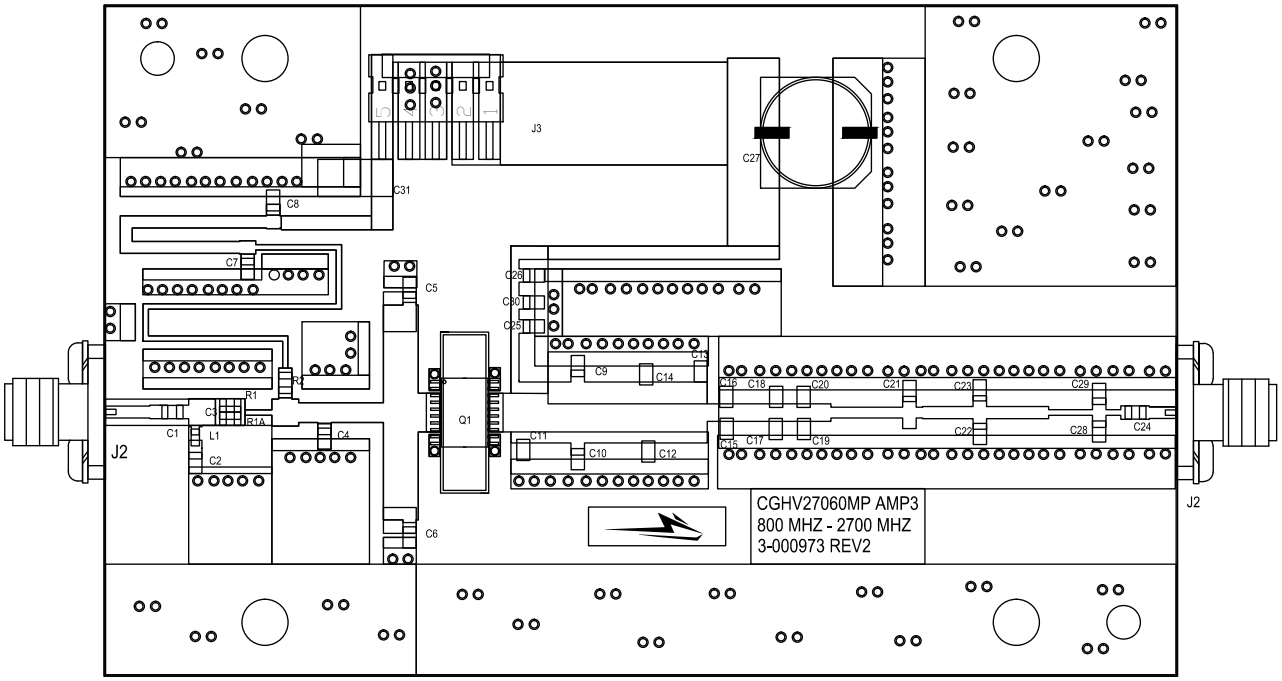


Figure 4. Power, Drain Efficiency and Gain vs Frequency of CGHV27060MP-AMP3
P_{IN} = 37 dBm, V_{DD} = 50 V, I_{DQ} = 120 mA

CGHV27060MP-AMP3 Demonstration Amplifier Circuit Schematic



CGHV27060MP-AMP3 Demonstration Amplifier Circuit Outline



CGHV27060MP-AMP3 Bill of Materials

Designator	Description	Qty
C1	CAP, 18pF, 5%, 0805, ATC	1
C2	CAP, 22pF, 5%, 0805, ATC	1
C3	CAP, 4.7pF, 5%, 0805, ATC	1
C4,C5,C6, C22, C23, C28, C29	CAP, 0.1pF, 5%, 0805, ATC	7
C7, C25	CAP, 240pF, 5%, 0805, ATC	2
C8,C26	CAP, 33000pF, 0805, 100V, X7R	2
C16,C19,	CAP, 0.9pF, 5%, 0805, ATC	2
C9, C10	CAP, 0.8pF, 5%, 0805, ATC	2
C11,C12,C14,C15,C18	CAP, 0.4pF, 5%, 0805, ATC	5
C13,C17,C21	CAP, 1pF, 5%, 0805, ATC	3
C24	CAP, 20pF, 5%, 0805, ATC	1
C30	CAP, 470pF, 5%, 0603, X7R	1
C27	CAP, 33µF	1
C31	CAP, 10µF, 16V, TANTALUM	1
C20	CAP 0.7pF	1
L1	IND, 36nH, 603	1
R1,R1A	RES, 24 Ohms, 805 IMS	1
R2	RES, 120 Ohms, 0805	1
–	PCB, RO4350, CGHV27060MP Applications Board, 4" X 2.5" X 0.02”	1
–	BASEPLATE, Cu, 4” X 2.5” X 0.5”	1
–	2-56 SOC HD SCREW 1/4 SS	4
–	#2 SPLIT LOCKWASHER SS	4
J1,J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST, 20MIL	2
J3	HEADER RT>PLZ .1CEN LK 5POS	1
Q1	Transistor CGHV27060MP	1

Electrical Characteristics When Tested in CGHV27060MP-AMP4, MILCOM

Characteristics	Symbol	Typ.	Max.	Units	Conditions
RF Characteristics[1] (T_C = 25°C, F_0 = 0.1 - 1.0 GHz unless otherwise noted)					
Small Signal Gain	G	16.5	–	dB	V_{DD} = 45 V, I_{DQ} = 120 mA
Output Power	P_{OUT}	47.8	–	dBm	V_{DD} = 45 V, I_{DQ} = 120 mA, P_{IN} = 35 dBm
Drain Efficiency	η	51.1	–	%	
Output Mismatch Stress	VSWR	–	3:1	Ψ	No damage at all phase angles, V_{DD} = 45 V, I_{DQ} = 120 mA, P_{IN} = 35 dBm

Note:
[1] Measured in CGHV27060MP-AMP4 Application Circuit

Typical Performance in Application Circuit CGHV27060MP-AMP4, MILCOM

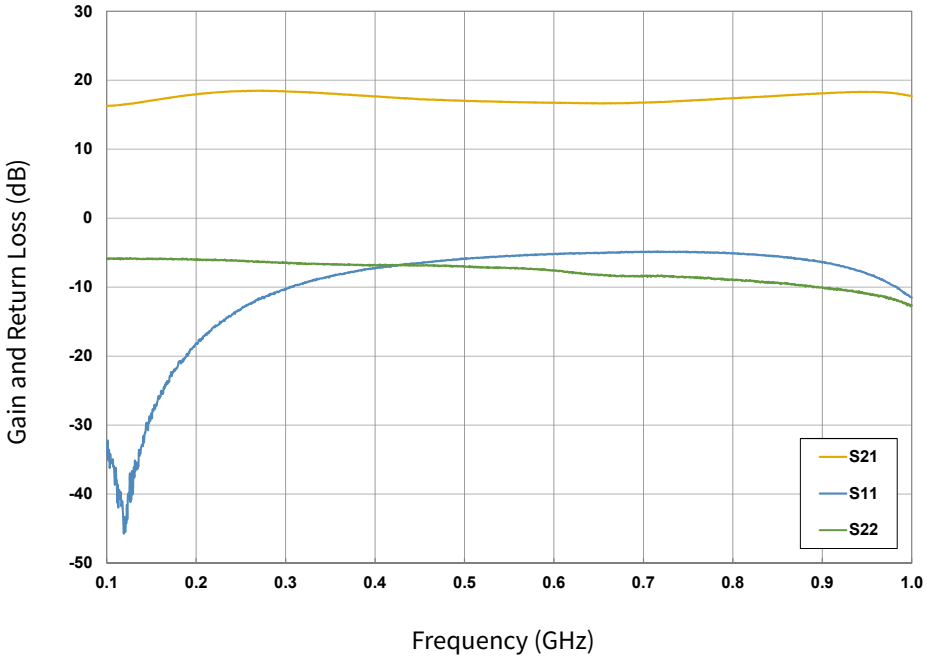


Figure 5. Small Signal Gain and Return Losses of the CGHV27060MP Measured in Demonstration Amplifier Circuit CGHV27060MP-AMP4
V_{DD} = 45 V, I_{DQ} = 120 mA

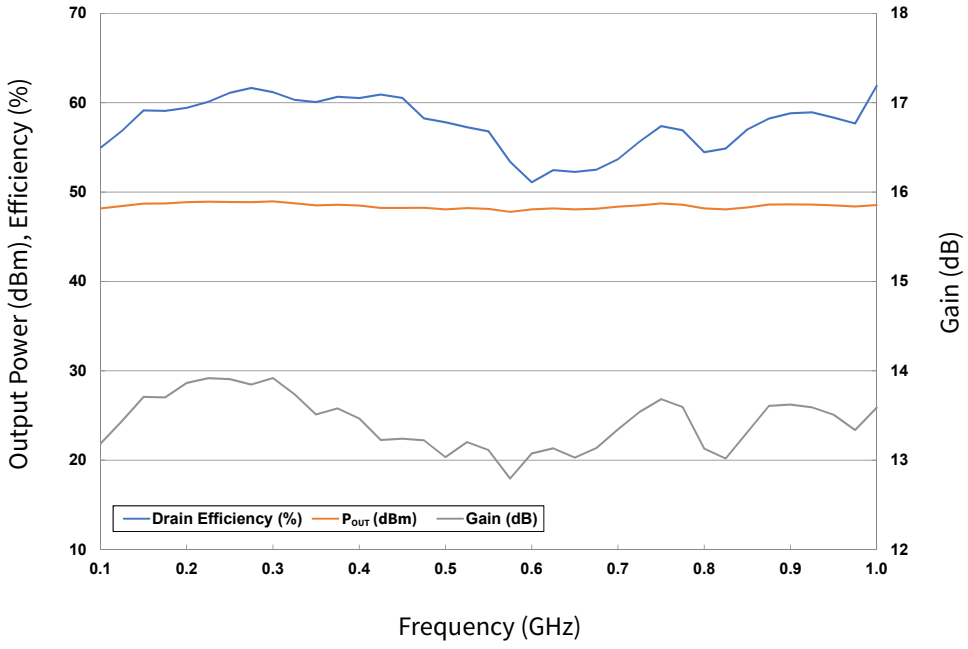
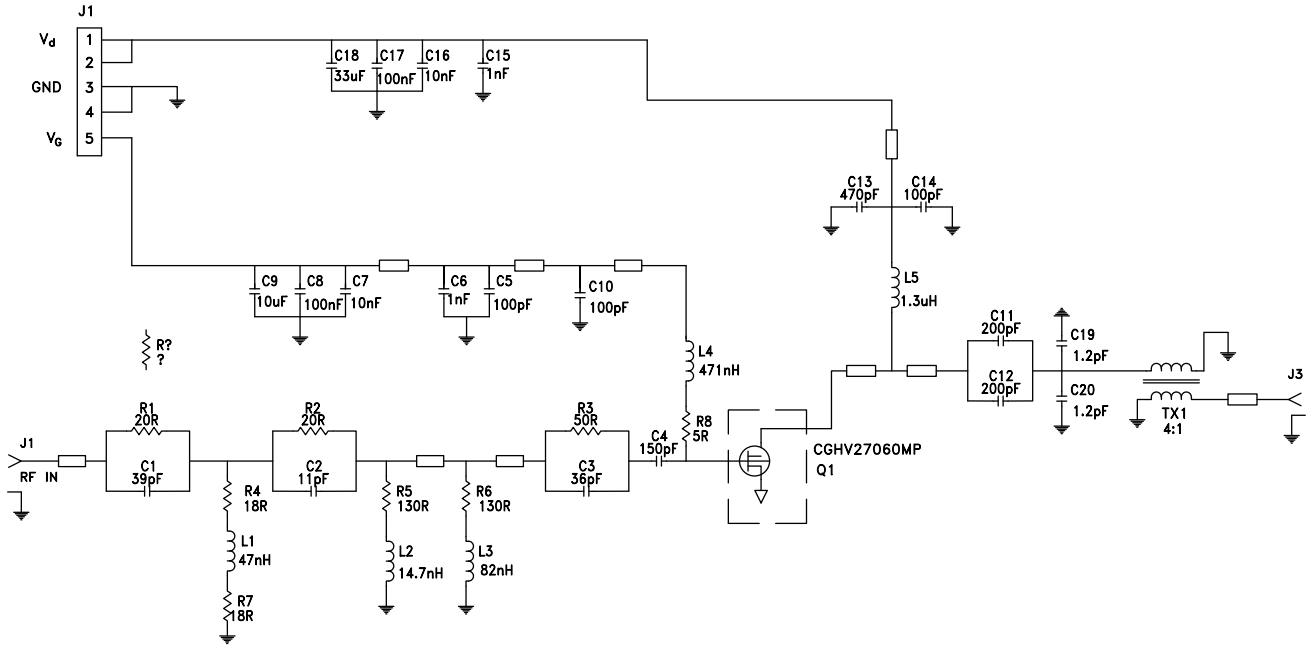
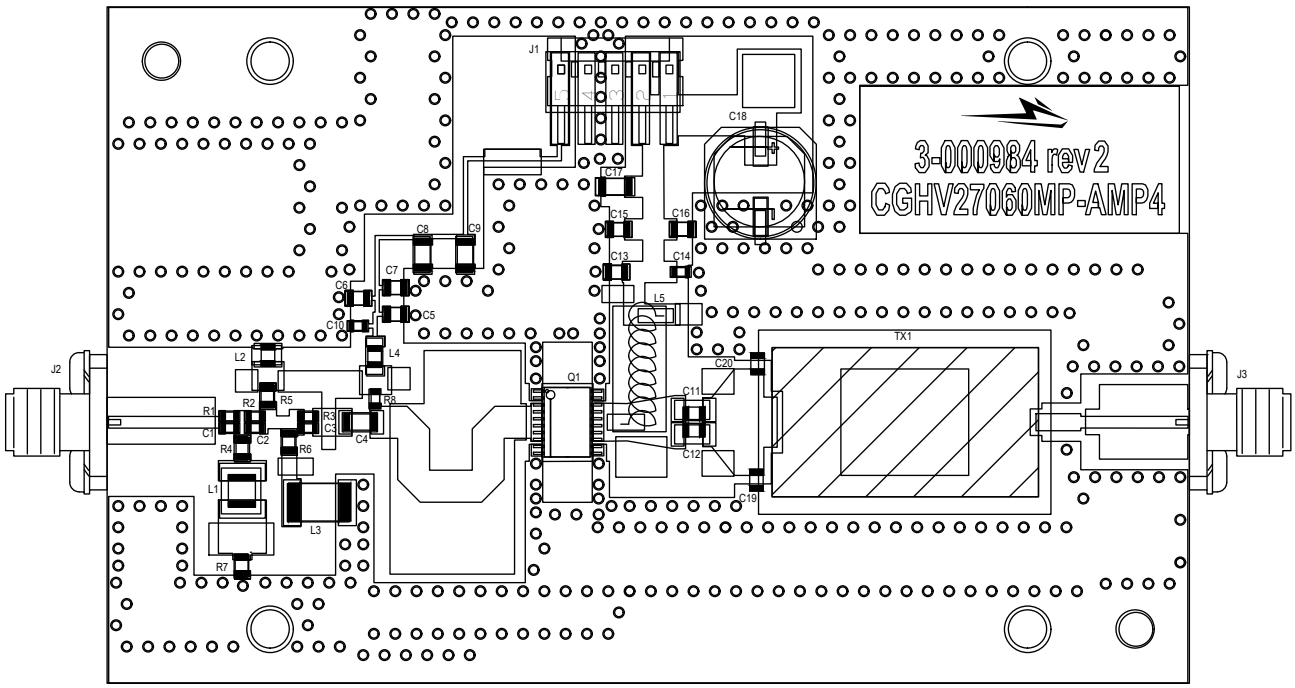


Figure 6. Power, Drain Efficiency, and Gain vs Frequency for the CGHV27060MP Measured in Demonstration Amplifier Circuit CGHV27060MP-AMP4
V_{DD} = 45 V, I_{DQ} = 120 mA

CGHV27060MP-AMP4 Demonstration Amplifier Circuit Schematic



CGHV27060MP-AMP4 Demonstration Amplifier Circuit Outline



CGHV27060MP-AMP4 Bill of Materials

Designator	Description	Qty
R4,7	RES, 16W, 0805, 2%, 18 OHMS, IMS	2
R1,2	RES, 13W, 0603, 5%, 20 OHMS, IMS	2
R3	RES, 13W, 0603,5%, 50 OHMS, IMS	1
R5, 6	RES, 25W, 0805, 5%, 130 OHMS, IMS	2
C19, C20	CAP, 1.2pF, +/-0.1pF, 0805, ATC600F	2
C2	CAP, 11pF, +/-2%, 0603, ATC600S	1
C3	CAP, 36pF, +/-2%, 0603, ATC600S	1
C1	CAP, 39pF, +/-2%, 0603, ATC600S	1
C10,14	CAP, 100pF, +/-5%, 0603, 100V, COG	2
C4	CAP, 150pF, +/-5%, ATC800B	1
C11, 12	CAP, 200pF, +/-5%, 0805, ATC600F	2
C5, 13	CAP, 470pF, +/-5%, 0805, 100V, X7R	2
C6, 15	CAP, 1nF, 0805, 100V, X7R	2
C7, 16	CAP, 10nF, 0805, 100V, X7R	2
C8, 17	CAP, 100nF, 1206, 100V, X7R	2
C9	CAP, 10µF, 10%, 1206, 16V, X5R	1
C18	CAP, 33µF, 20%, F CASE, 63V	1
L2	IND, 14.7nH, 2% Air Core, Coilcraft	1
L1	IND, 47nH, 5% Air Core, Coilcraft	1
L3	IND, 82nH, 5% Air Core, Coilcraft	1
L4	IND, 471nH, 5%, 0805 Chip Inductor, Coilcraft	1
–	Copper Plate	1
J2,J3	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST	2
–	PCB, Rogers RO4350B 20mils 1oz.Cu 101x64mm	1
–	BASEPLATE, 4.00 X 2.50 X .49” modified	1
J1	HEADER RT>PLZ .1CEN LK 5POS	1
–	2-56 SOC HD SCREW 1/4 SS	4
–	#2 SPLIT LOCKWASHER SS	4
TX1	Transformer, 30-1000 MHz SMD, IPP-5014	1
Q1	Transistor CGHV27060MP	1

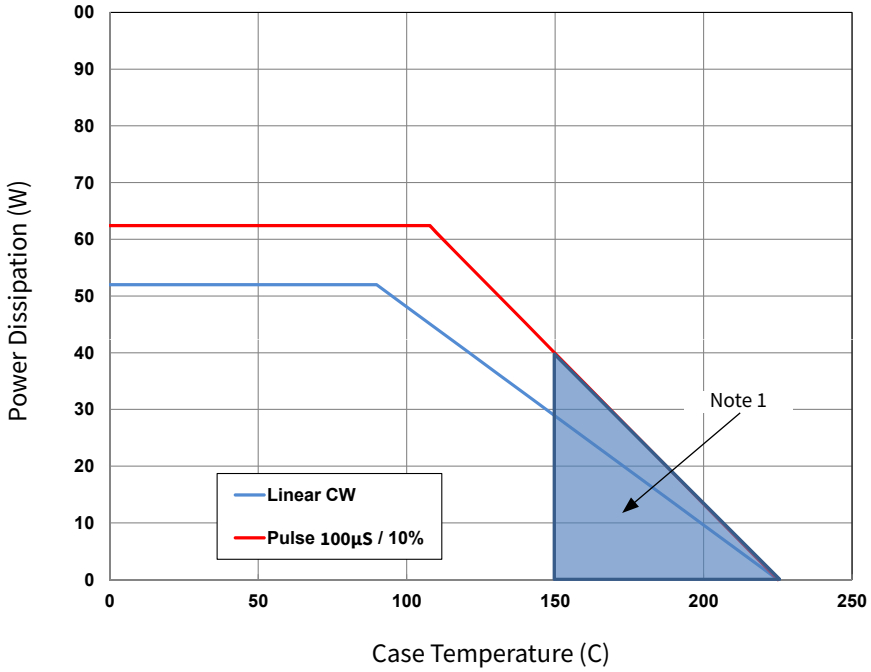
Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Classification Level	Test Methodology
Human Body Model	HBM	TBD	ANSI/ESDA/JEDEC JS-001 Table 3	JEDEC JESD22 A114-D
Charge Device Model	CDM	TBD	ANSI/ESDA/JEDEC JS-002 Table 3	JEDEC JESD22 C101-C

Moisture Sensitivity Level (MSL) Classification

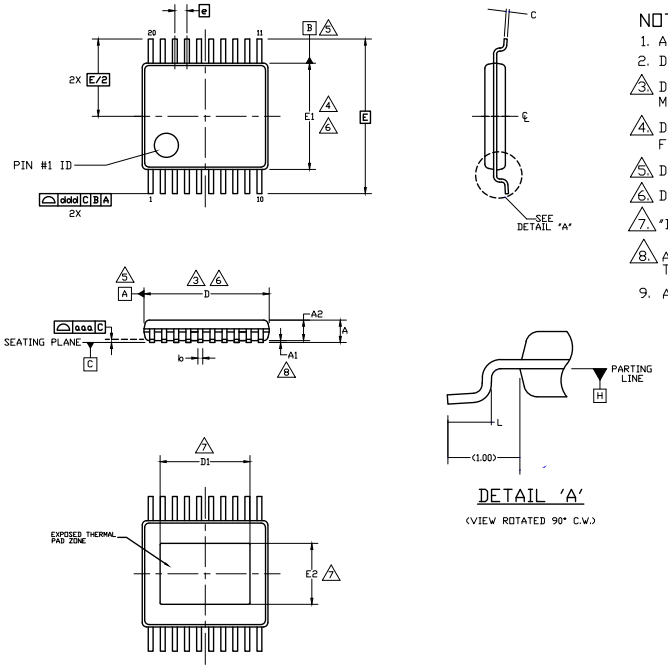
Parameter	Symbol	Level	Test Methodology
Moisture Sensitivity Level	MSL	3 (168 hours)	IPC/JEDEC J-STD-20

CGHV27060MP Power Dissipation De-rating Curve



Note:
[1] Area exceeds Maximum Case Temperature (See Page 2).

Product Dimensions CGHV27060MP (4.4 mm 20-Lead Package)



NOTES:
1. ALL DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. DIMENSIONING & TOLERANCES PER ASME. Y14.5M-1994.
3. DIMENSION 'D' DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.
4. DIMENSION 'E1' DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 PER SIDE
5. DATUMS A AND B TO BE DETERMINED AT DATUM PLANE H.
6. DIMENSIONS 'D' AND 'E1' TO BE DETERMINED AT DATUM PLANE H.
7. "D1" AND "E2" DIMENSIONS DO NOT INCLUDE MOLD FLASH.
8. A1 IS DEFINED AS THE VERTICAL CLEARANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.
9. ALL PLATED SURFACES ARE 100% TIN MATTE FINISH. 0.010 mm +/- 0.005 mm.

SYMBOL	COMMON DIMENSIONS			NOTE
	MIN.	NOM.	MAX.	
A	——	——	1.15	
A1	0.05	——	0.15	8
A2	0.80	0.91	1.02	
aaa	0.076			
b	0.20	–	0.33	
c	0.10	–	0.23	
D	6.40	6.50	6.60	3,6
E1	4.30	4.40	4.50	4,6
e	0.65 BSC			
E	6.40 BSC			
L	0.45	0.60	0.75	
D1	3.61	3.72	3.83	7
E2	2.41	2.52	2.63	7
ddd	0.20			

PINOUT TABLE

PIN	FUNCTION
1	GND
2	GND
3	RF INPUT
4	RF INPUT
5	RF INPUT
6	RF INPUT
7	RF INPUT
8	RF INPUT
9	GND
10	GND
11	GND
12	GND
13	RF OUTPUT
14	RF OUTPUT
15	RF OUTPUT
16	RF OUTPUT
17	RF OUTPUT
18	RF OUTPUT
19	GND
20	GND

Part Number System

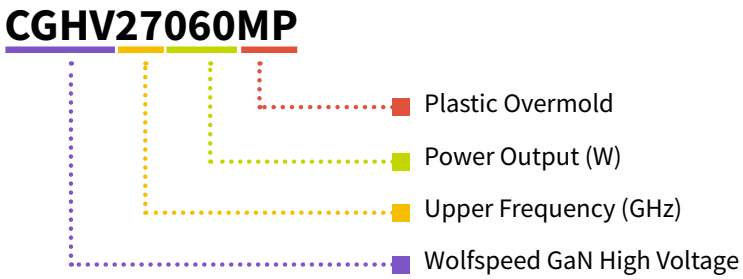


Table 1.

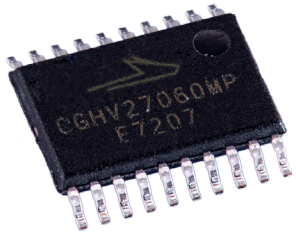
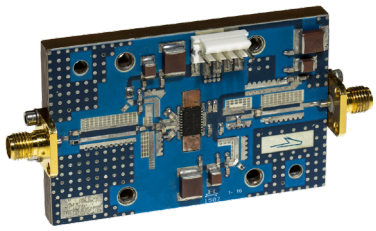
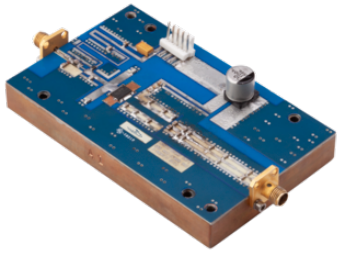
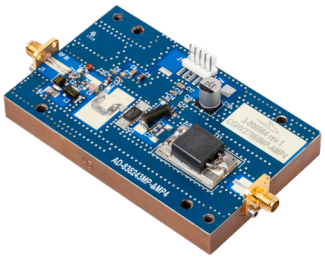
Parameter	Value	Units
Upper Frequency[1]	2.7	GHz
Power Output	60	W
Package	MP	–

Note:
[1] Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Table 2.

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples	1A = 10.0 GHz 2H = 27.0 GHz

Product Ordering Information

Order Number	Description	Unit of Measure	Image
CGHV27060MP	GaN HEMT	Each	
CGHV27060MP-AMP1	Test board with GaN HEMT installed	Each	
CGHV27060MP-AMP3	Test board with GaN HEMT installed	Each	
CGHV27060MP-AMP4	Test board with GaN HEMT installed	Each	

For more information, please contact:

4600 Silicon Drive
Durham, NC 27703 USA
Tel: +1.919.313.5300
www.wolfspeed.com/RF

Sales Contact
RFSales@wolfspeed.com

RF Product Marketing Contact
RFMarketing@wolfspeed.com

Notes & Disclaimer

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